

# Amplifier, Power, 2.0W 2.5-5.0 GHz

MAAP-000066-PKG003  
Rev -  
Preliminary Datasheet

## Features

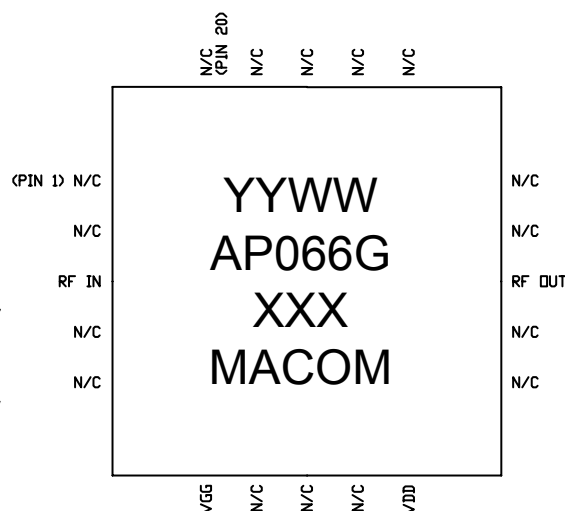
- ◆ 2.0 Watt Saturated Output Power Level
- ◆ Variable Drain Voltage (6-10V) Operation
- ◆ MSAG™ Process
- ◆ 5x5 mm 20 Lead PQFN Package

## Description

The MAAP-000066-PKG003 is a 4-stage 2.0 W power amplifier with on-chip bias networks in a 20 lead PQFN package, allowing easy assembly. This product is fully matched to 50 ohms on both the input and output. It can be used as a power amplifier stage or as a driver stage in high power applications.

Each device is 100% RF tested to ensure performance compliance. The part is fabricated using M/A-COM's GaAs Multifunction Self-Aligned Gate (MSAG™) Process.

The 5 mm PQFN package has a lead-free lead finish that is RoHS compliant and compatible with a 260°C reflow temperature. The package also features low lead inductance and an excellent thermal path. The MTTF is 1,000,000 hours at 170°C.



## Primary Applications

- ◆ Point-to-Point Radios
- ◆ Point-to-Multipoint Radios
- ◆ SatCom
- ◆ Broadband Wireless Access

## Also Available in:

		SAMPLE BOARD
Description	Die	Plastic Package
Part Number	MAAPGM0066-DIE	MAAP-000066-SMB003

**Electrical Characteristics:**  $T_C = 30^\circ\text{C}^1$ ,  $Z_0 = 50\Omega$ ,  $V_{DD} = 8\text{V}$ ,  $I_{DQ} = 660\text{ mA}^2$ ,  $P_{in} = 6\text{dBm}$ ,  $R_G = 150\Omega$

Parameter	Symbol	Typical	Units
Bandwidth	f	2.5-5.0	GHz
Output Power	$P_{OUT}$	33.5	dBm
Power Added Efficiency	PAE	30	%
1-dB Compression Point	$P_{1dB}$	33	dBm
Small Signal Gain	G	28	dB
Input VSWR	VSWR	1.5:1	—
Output VSWR	VSWR	2.5:1	—
Gate Supply Current	$I_{GG}$	< 10	mA
Drain Supply Current	$I_{DD}$	< 1	A
Output Third Order Intercept	$IP_3$	42	dBm
3 <sup>rd</sup> Order Intermodulation Distortion, Single Carrier Level = 23 dBm	IM3	-17	dBm

1.  $T_C$  = Case Temperature.
2. Adjust  $V_{GG}$  between -2.6 to -1.2 to achieve indicated  $I_{DQ}$ .

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## Maximum Ratings<sup>3</sup>

Parameter	Symbol	Absolute Maximum	Units
Input Power	$P_{IN}$	11.0	dBm
Drain Supply Voltage	$V_{DD}$	+12.0	V
Gate Supply Voltage	$V_{GG}$	-3.0	V
Quiescent Drain Current (No RF)	$I_{DQ}$	1.04	A
Quiescent DC Power Dissipated (No RF)	$P_{DISS}$	10.4	W
Junction Temperature	$T_J$	170	°C
Storage Temperature	$T_{STG}$	-55 to +150	°C

3. Operation beyond these limits may result in permanent damage to the part.

## Recommended Operating Conditions<sup>4</sup>

Characteristic	Symbol	Min	Typ	Max	Unit
Drain Supply Voltage	$V_{DD}$	6.0	8.0	10.0	V
Gate Supply Voltage	$V_{GG}$	-2.6	-1.7	-1.2	V
Input Power	$P_{IN}$		6	9	dBm
Thermal Resistance	$\Theta_{JC}$		12.8		°C/W
Case Temperature	$T_B$			Note 5	°C

4. Operation outside of these ranges may reduce product reliability.

5. Case Temperature =  $170^{\circ}\text{C} - \Theta_{JC} * V_{DD} * I_{DQ}$

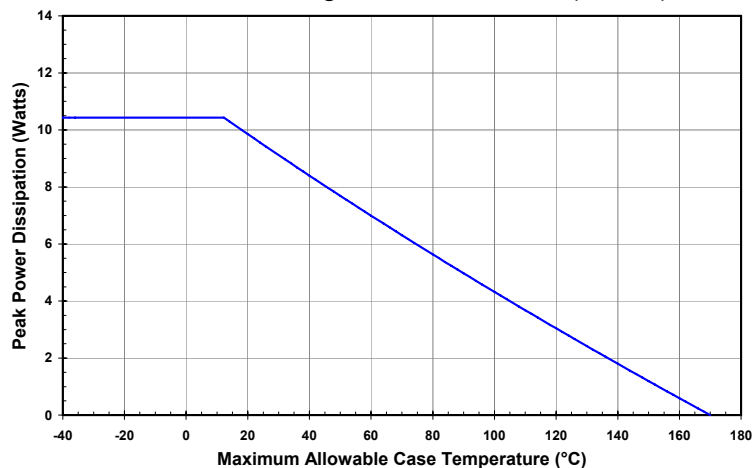


## Operating Instructions

This device is static sensitive. Please handle with care. To operate the device, follow these steps.

1. Apply  $V_{GG} = -1.7\text{ V}$ ,  $V_{DD} = 0\text{ V}$ .
2. Ramp  $V_{DD}$  to desired voltage, typically 8 V.
3. Adjust  $V_{GG}$  to set  $I_{DQ}$ , (approximately @  $-1.7\text{V}$ ).
4. Set RF input.
5. Power down sequence in reverse. Turn gate voltage off last.

Power Derating Curve, Quiescent (No RF)



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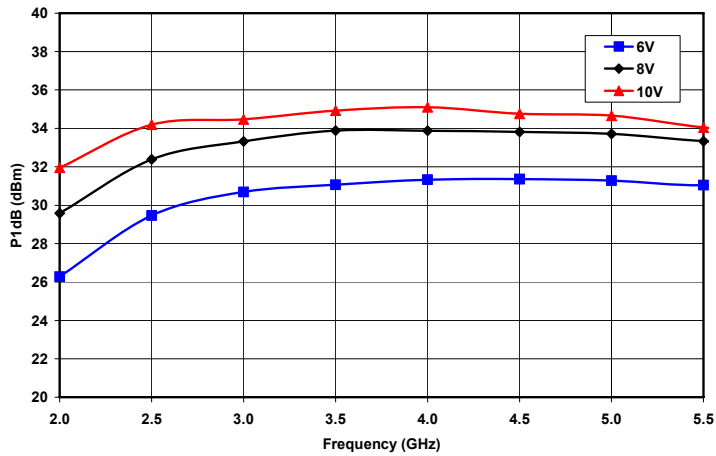


Figure 1. 1 dB Compression Point vs. Frequency and Drain Voltage at IDQ = 660mA

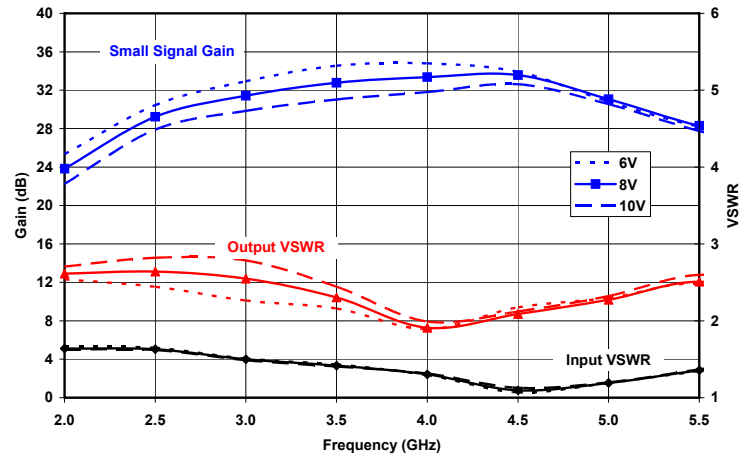


Figure 2. Small Signal Gain and Input & Output VSWR vs. Frequency and Drain Voltage at IDQ = 660mA

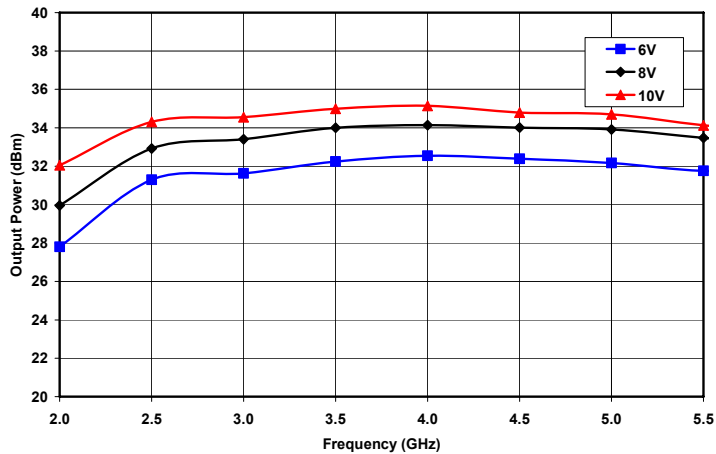


Figure 3. Saturated Output Power vs. Frequency and Drain Voltage at IDQ = 660mA

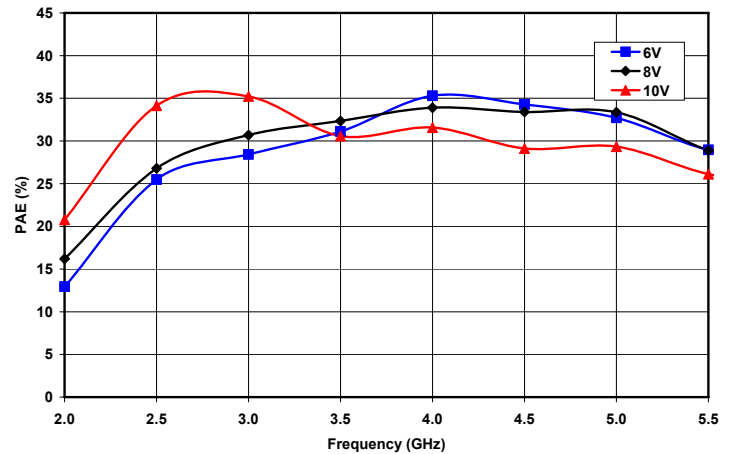


Figure 4. Saturated Power Added Efficiency vs. Frequency and Drain Voltage at IDQ = 660mA

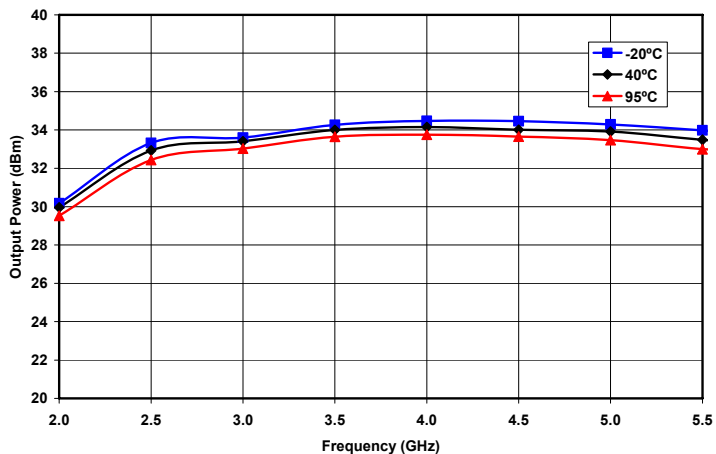


Figure 5. Saturated Output Power vs. Frequency and Case Temperature at VD = 8V and IDQ = 660mA

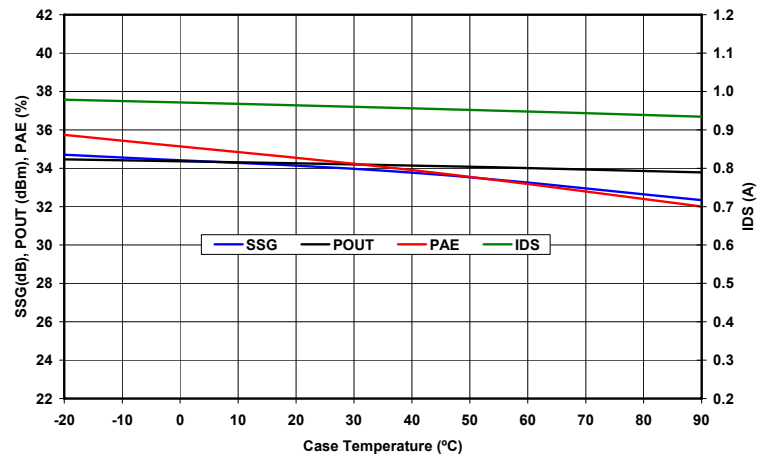


Figure 6. Small Signal Gain & Saturated Output Power, Power Added Efficiency and Drain Current vs. Case Temperature at 4.0 GHz, VD = 8V and IDQ = 660mA

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**VD = 6V**

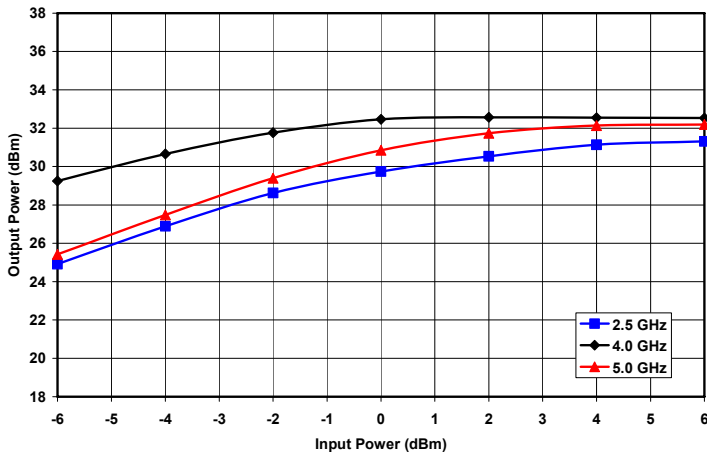


Figure 7. Output Power vs. Input Power and Frequency at VD = 6V and IDQ = 660mA

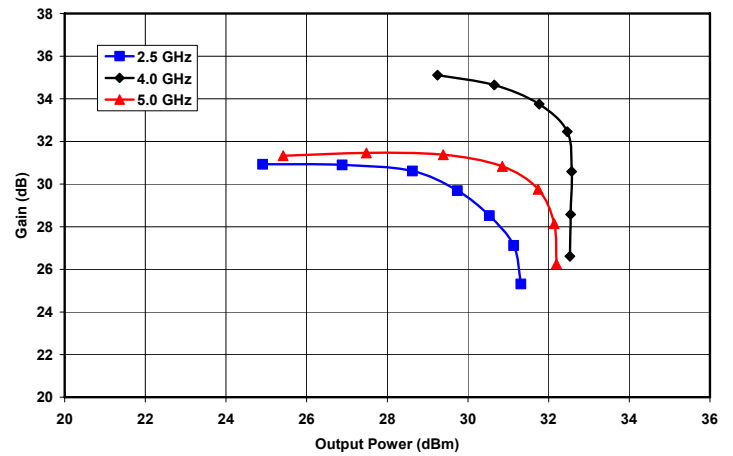


Figure 8. Gain vs. Output Power and Frequency at VD = 6V and IDQ = 660mA

**VD = 8V**

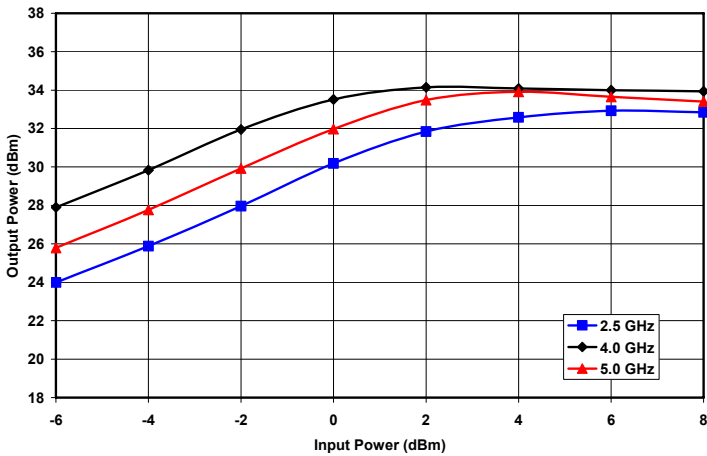


Figure 9. Output Power vs. Input Power and Frequency at VD = 8V and IDQ = 660mA

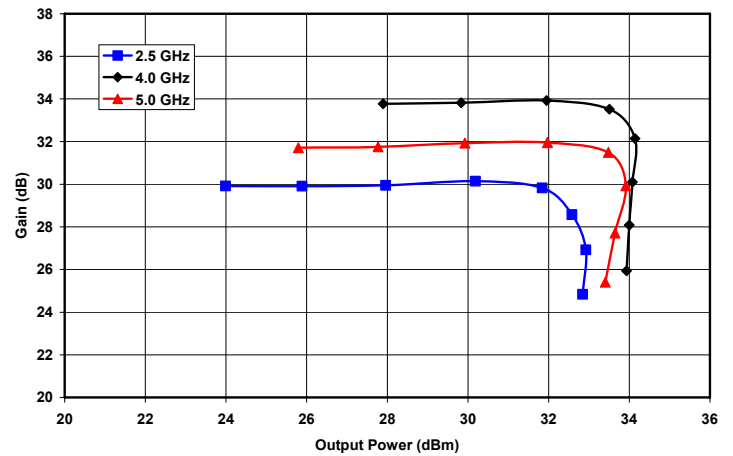


Figure 10. Gain vs. Output Power and Frequency at VD = 8V and IDQ = 660mA

**VD = 10V**

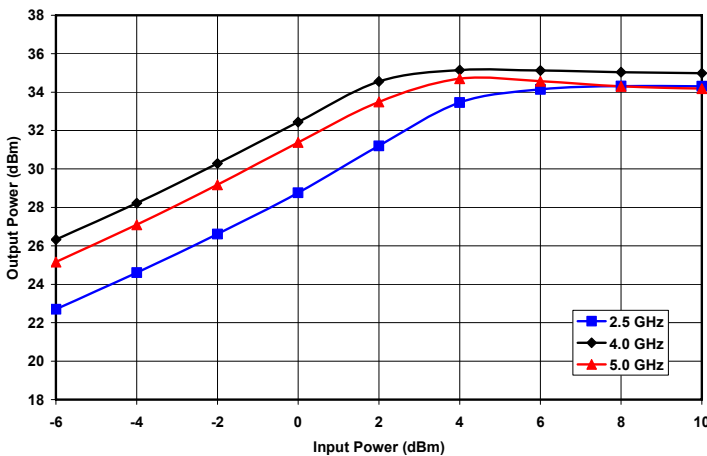


Figure 11. Output Power vs. Input Power and Frequency at VD = 10V and IDQ = 660mA

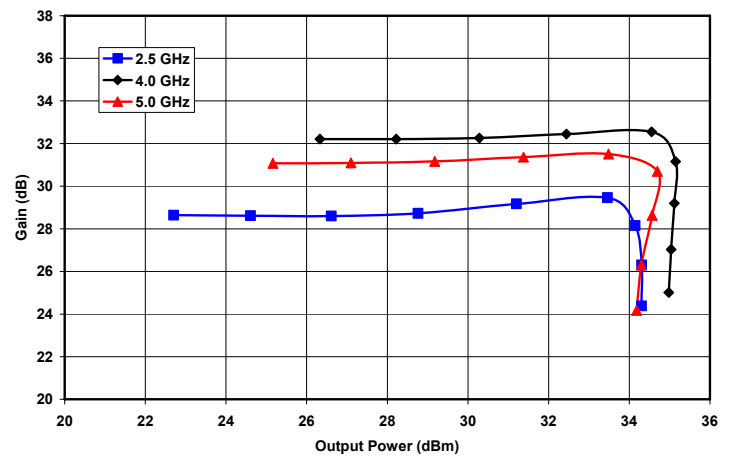


Figure 12. Gain vs. Output Power and Frequency at VD = 10V and IDQ = 660mA

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**VD = 6V**

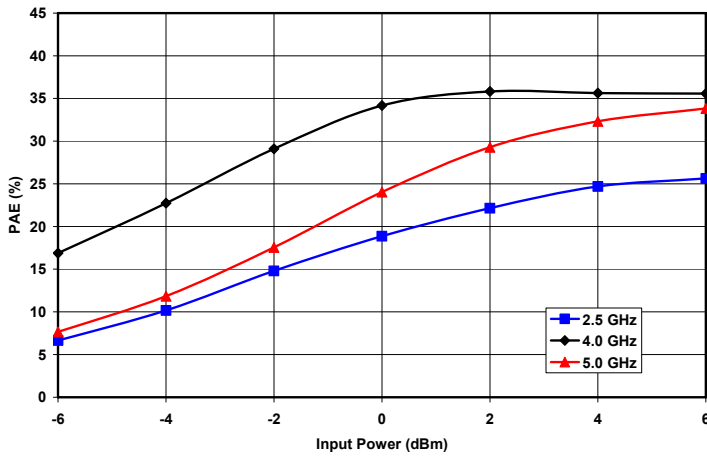


Figure 13. Power Added Efficiency vs. Input Power and Frequency at VD = 6V and IDQ = 660mA

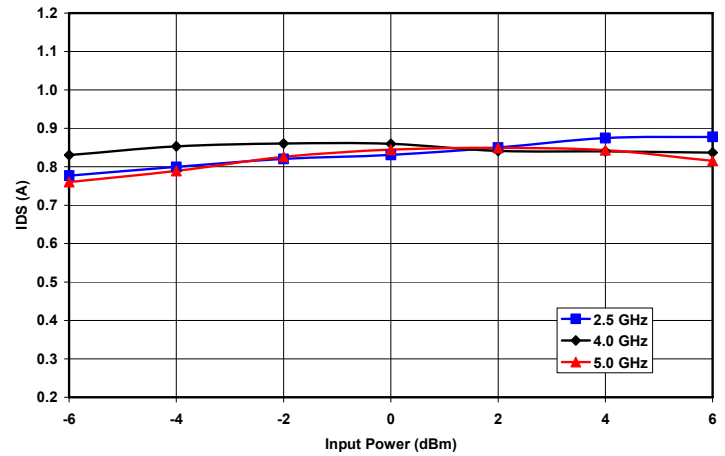


Figure 14. Drain Current vs. Input Power and Frequency at VD = 6V and IDQ = 660mA

**VD = 8V**

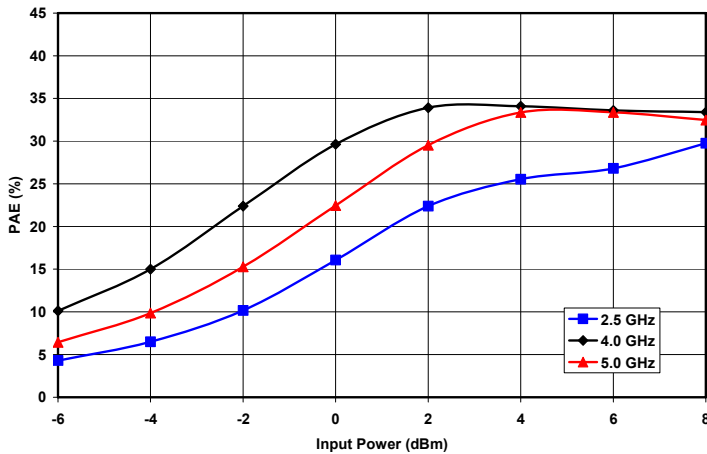


Figure 15. Power Added Efficiency vs. Input Power and Frequency at VD = 8V and IDQ = 660mA

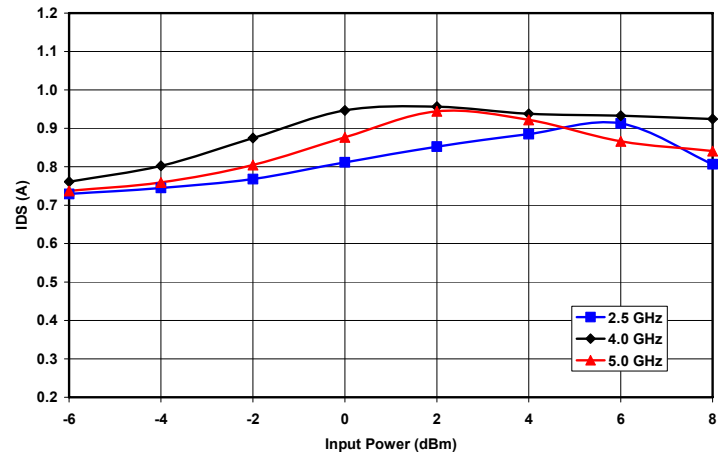


Figure 16. Drain Current vs. Input Power and Frequency at VD = 8V and IDQ = 660mA

**VD = 10V**

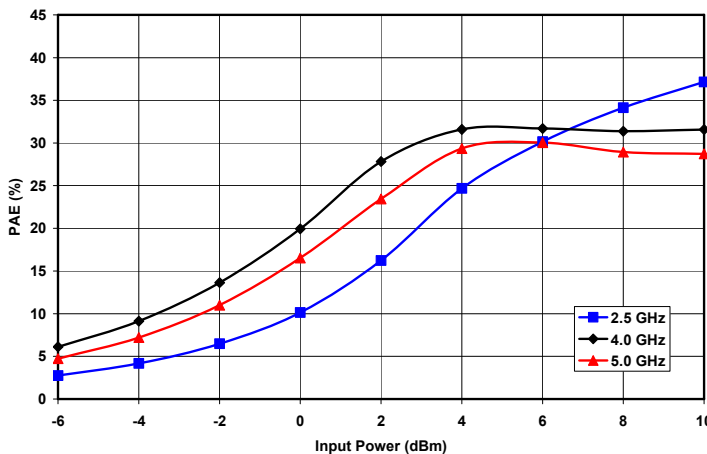


Figure 17. Power Added Efficiency vs. Input Power and Frequency at VD = 10V and IDQ = 660mA

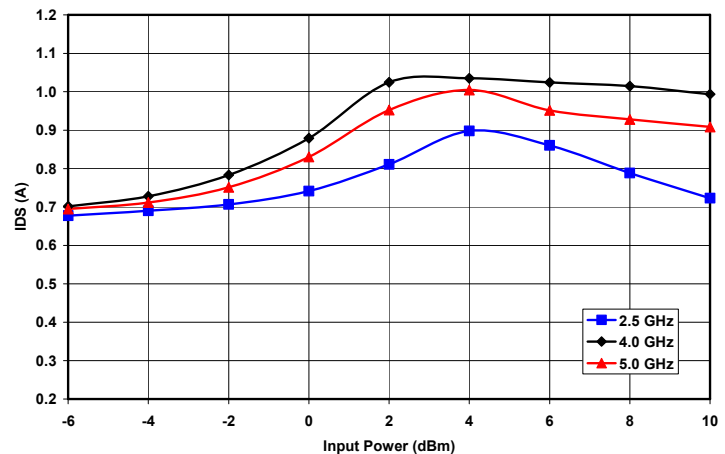


Figure 18. Drain Current vs. Input Power and Frequency at VD = 10V and IDQ = 660mA

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**VD = 6V**

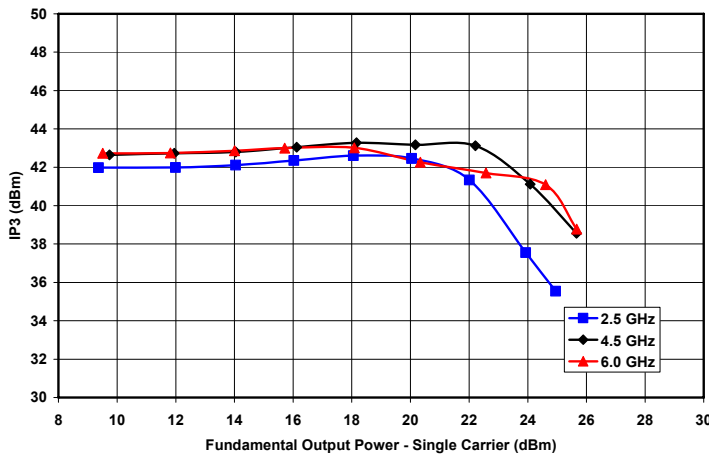


Figure 19. Third Order Intercept vs. Output Power and Frequency at VD = 6V and IDQ = 660mA

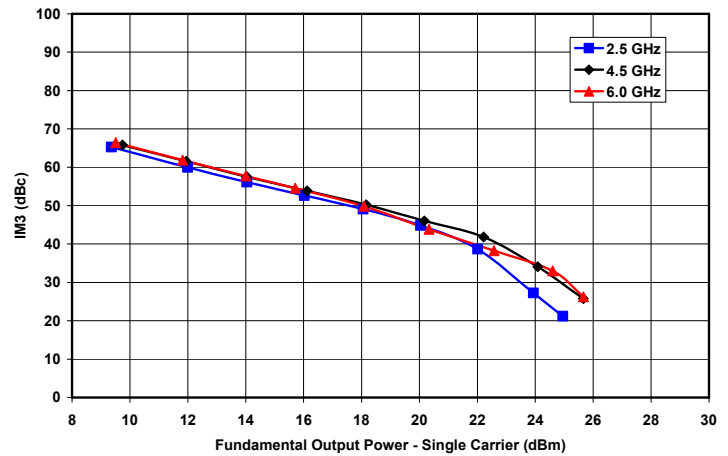


Figure 20. Third Order Intermod vs. Output Power and Frequency at VD = 6V and IDQ = 660mA

**VD = 8V**

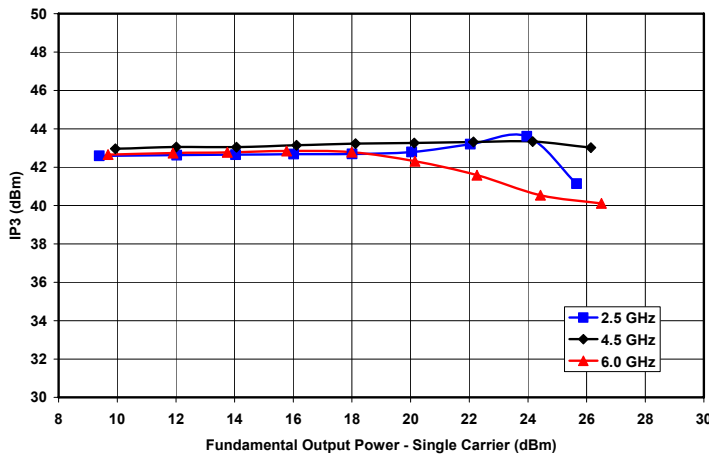


Figure 21. Third Order Intercept vs. Output Power and Frequency at VD = 8V and IDQ = 660mA

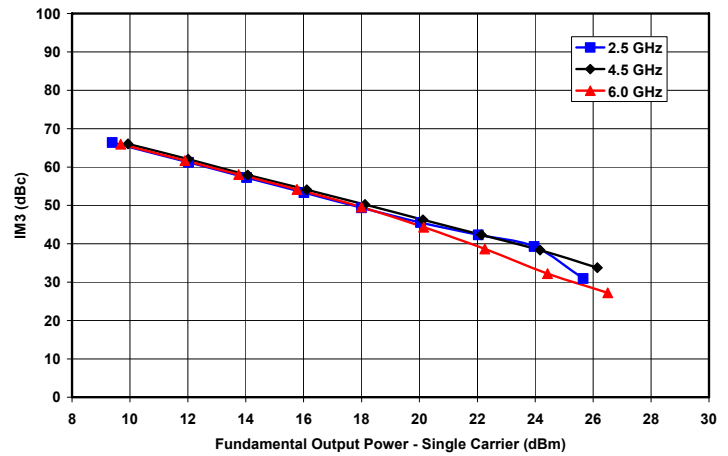


Figure 22. Third Order Intermod vs. Output Power and Frequency at VD = 8V and IDQ = 660mA

**VD = 10V**

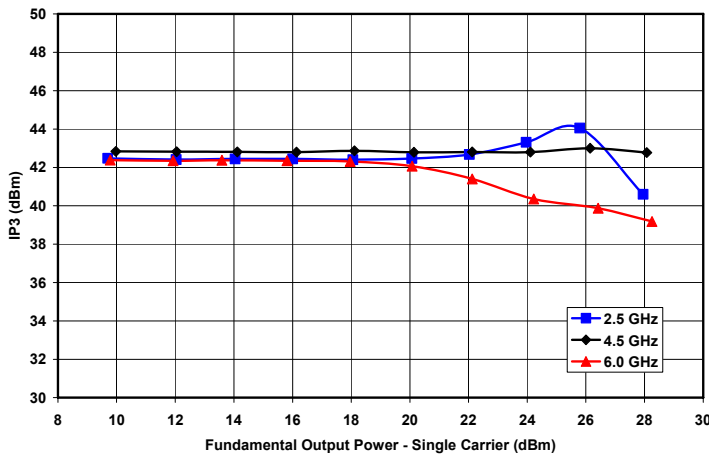


Figure 23. Third Order Intercept vs. Output Power and Frequency at VD = 10V and IDQ = 660mA

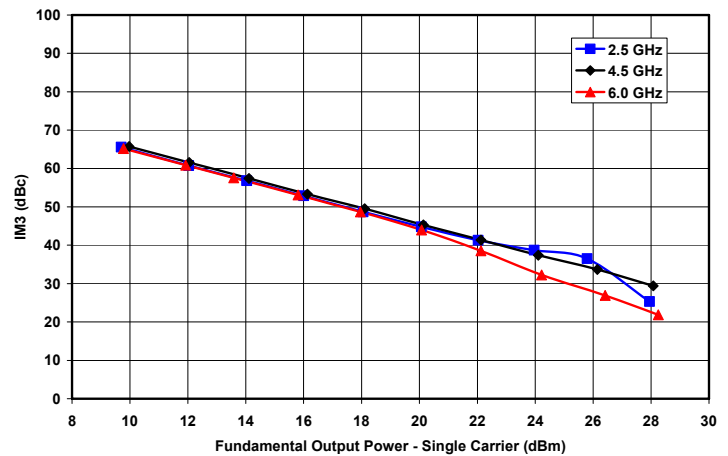


Figure 24. Third Order Intermod vs. Output Power and Frequency at VD = 10V and IDQ = 660mA

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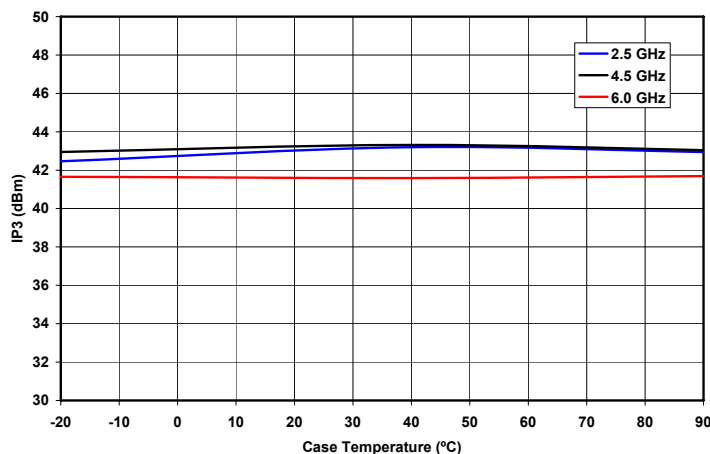


Figure 25. Third Order Intercept vs. Case Temperature and Frequency at Single Carrier Output Power Level = 16 dBm, VD = 8V and IDQ = 660mA

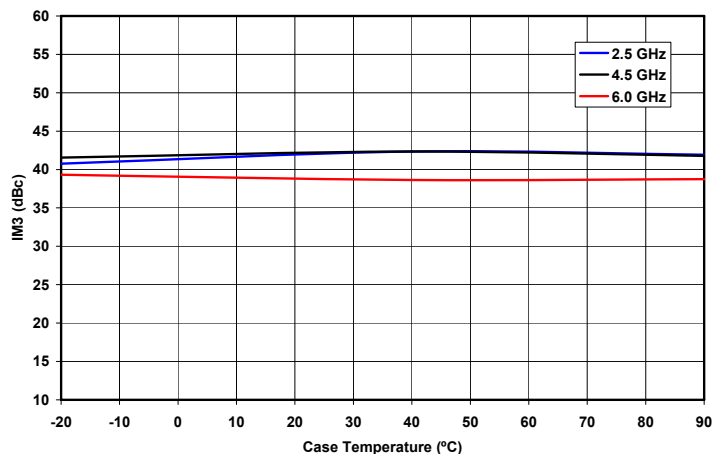
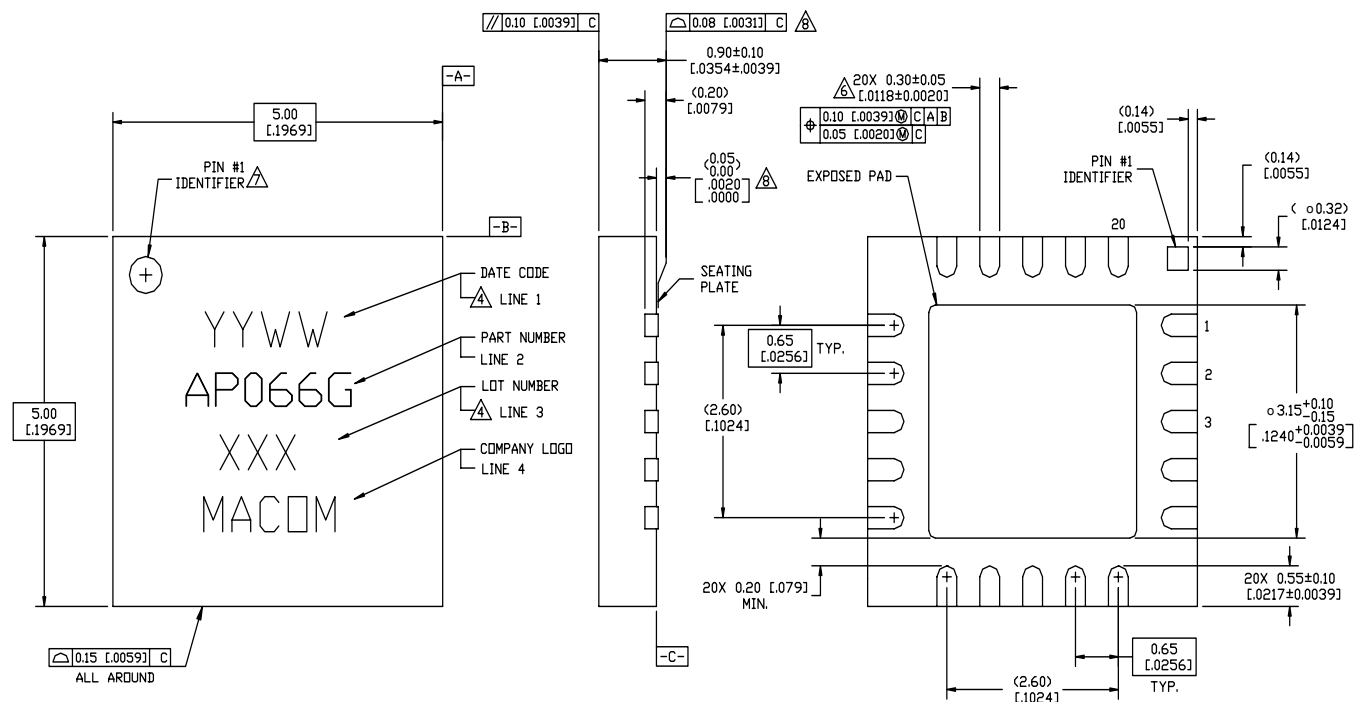


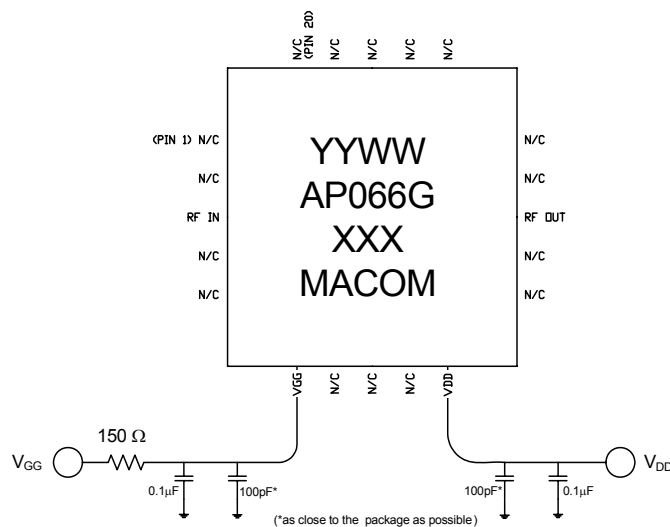
Figure 26. Third Order Intermod vs. Case Temperature and Frequency at Single Carrier Output Power Level = 16 dBm, VD = 8V and IDQ = 660mA

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**Figure 27. 5x5 mm 20-Lead PQFN.**



**Figure 28. Recommended Bias Configuration.**

Note: The exposed pad centered on the package bottom must be connected to RF and dc ground for proper electrical and thermal operation.

Refer to M/A-COM Application Note **Surface Mounting Instructions for PQFN Packages #S2083\*** for assembly guidelines.

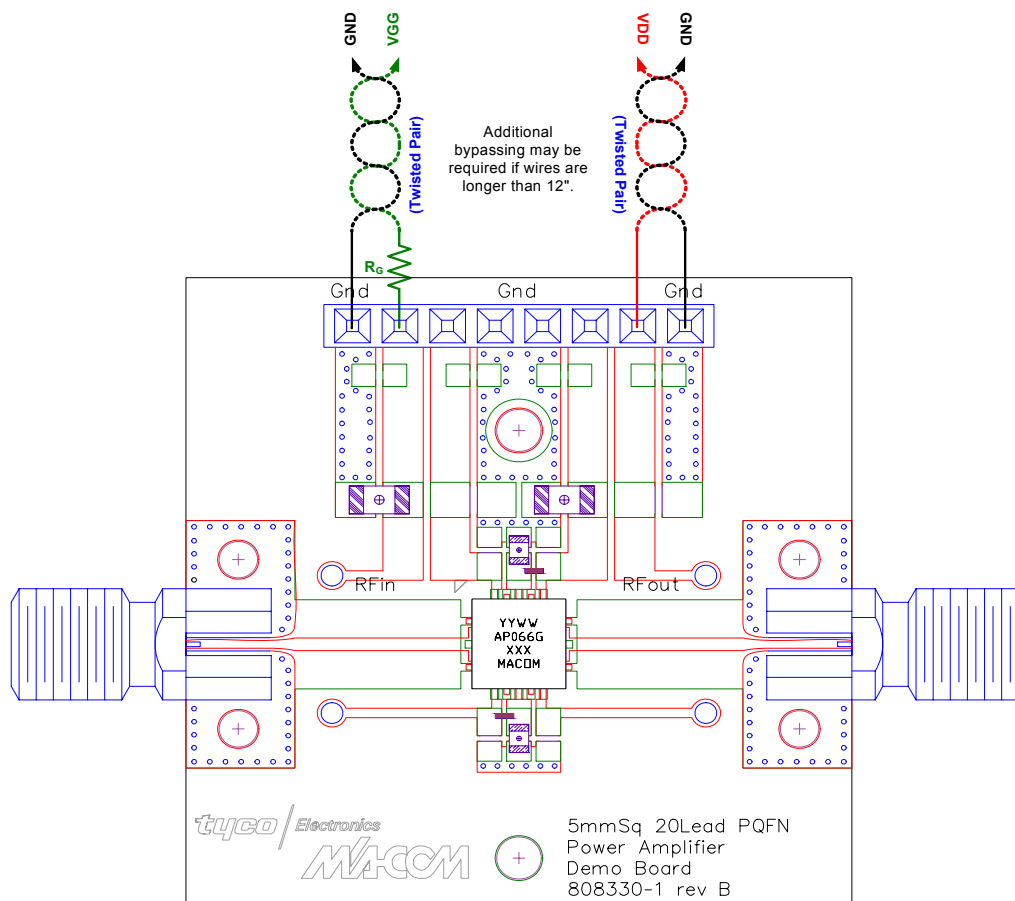
**Additional Precaution: All parts must receive a bake-out of 125°C for 24 hours prior to any solder reflow operation.**

\*Application Notes can be found by going to the Site Search Page of M/A-COM's web page (<http://www.macom.com/search/search.jsp>) and searching for the required Application Note.



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**Figure 29. Demonstration Board PN MAAP-000066-SMB003 (available upon request).**